



US/N 10/772,606

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Joseph E. Geusic et al.	Examiner:	Julio J. Maldonado
Serial No.:	10/772,606	Group Art Unit:	2823
Filed:	February 5, 2004	Docket:	303.390US4
Title:	INTEGRATED CIRCUITS USING OPTICAL FIBER INTERCONNECTS FORMED THROUGH A SEMICONDUCTOR WAFER		

SUPPLEMENTAL AMENDMENT UNDER 37 C.F.R. § 1.312

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Notice of Allowance and Notice of Allowability mailed July 28, 2005,
please amend as follows: